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FQP6N70

700V N-Channel MOSFET

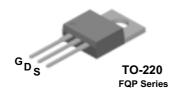
General Description

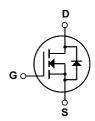
These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switch mode power supply.

Features

- 6.2A, 700V, R_{DS(on)} = 1.5 Ω @ V_{GS} = 10 V Low gate charge (typical 30 nC)
- Low Crss (typical 15 pF)
- · Fast switching
- · 100% avalanche tested
- · Improved dv/dt capability





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		FQP6N70	Units	
V _{DSS}	Drain-Source Voltage		700	V	
I _D	Drain Current - Continuous (T _C = 25°	°C)	6.2	A	
	- Continuous (T _C = 100	D°C)	3.9	А	
I _{DM}	Drain Current - Pulsed	(Note 1)	24.8	А	
V _{GSS}	Gate-Source Voltage		± 30	V	
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	600	mJ	
I _{AR}	Avalanche Current	(Note 1)	6.2	А	
E _{AR}	Repetitive Avalanche Energy	(Note 1)	14.2	mJ	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.5	V/ns	
P_{D}	Power Dissipation (T _C = 25°C)		142	W	
	- Derate above 25°C		1.14	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C	
T _L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C	

Thermal Characteristics

Symbol	Parameter	Тур	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		0.88	°C/W
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink	0.5		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		62.5	°C/W

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	aracteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	700			V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C		0.78		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 700 V, V _{GS} = 0 V			10	μΑ
		V _{DS} = 560 V, T _C = 125°C			100	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30 V, V _{DS} = 0 V			-100	nA
On Cha	aracteristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 3.1 A		1.16	1.5	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 50 V, I _D = 3.1 A (Note 4)		6.4		S
C _{oss} C _{rss}	Output Capacitance Reverse Transfer Capacitance	f = 1.0 MHz		125 15	150 120	pF pF
C _{rss}	-	1 - 1.0 WH12				•
Switchi	ing Characteristics					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 350 V, I _D = 6.2 A,		25	60	ns
t _r	Turn-On Rise Time	$R_G = 25 \Omega$		70	150	ns
$t_{d(off)}$	Turn-Off Delay Time			55	120	ns
t _f	Turn-Off Fall Time	(Note 4, 5)		50	110	ns
Qg	Total Gate Charge	$V_{DS} = 560 \text{ V}, I_{D} = 6.2 \text{ A},$		30	40	nC
Q_{gs}	Gate-Source Charge	V _{GS} = 10 V		6.5		nC
93		(Note 4, 5)		13		nC
Q _{gd}	Gate-Drain Charge	(Note 4, 5)				110
Q _{gd}	Gate-Drain Charge Source Diode Characteristics at					110
Q _{gd} Drain-S	,	nd Maximum Ratings			6.2	A
Q_{gd} Drain-S I_S	Source Diode Characteristics a	nd Maximum Ratings ode Forward Current			6.2	
Q _{gd}	Source Diode Characteristics at Maximum Continuous Drain-Source Dio	nd Maximum Ratings ode Forward Current				A
Q _{gd} Drain-S I _S I _{SM}	Maximum Pulsed Drain-Source Diode F	nd Maximum Ratings ode Forward Current Forward Current			24.8	A

- **Notes:**1. Repetitive Rating : Pulse width limited by maximum junction temperature 2. L = 29mH, I_{AS} = 6.2A, V_{DD} = 50V, R_G = 25 Ω, Starting T_J = 25°C 3. I_{SD} \leq 6.2A, di/dt \leq 200A/μs, V_{DD} \leq BV_{DSS}, Starting T_J = 25°C 4. Pulse Test : Pulse width \leq 300μs, Duty cycle \leq 2% 5. Essentially independent of operating temperature

Typical Characteristics

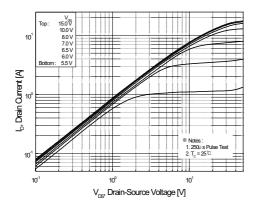


Figure 1. On-Region Characteristics

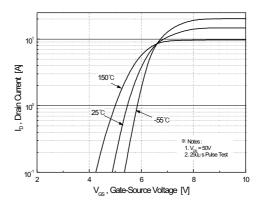


Figure 2. Transfer Characteristics

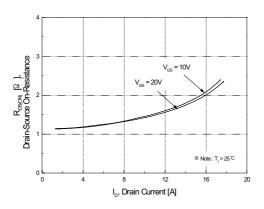


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

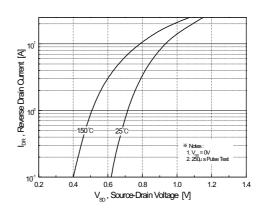


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

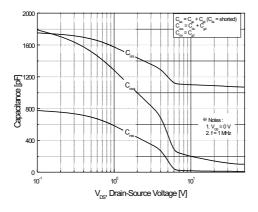


Figure 5. Capacitance Characteristics

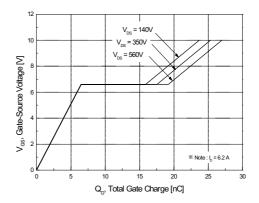


Figure 6. Gate Charge Characteristics

Typical Characteristics (Continued)

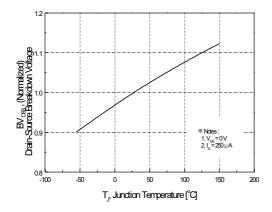


Figure 7. Breakdown Voltage Variation vs. Temperature

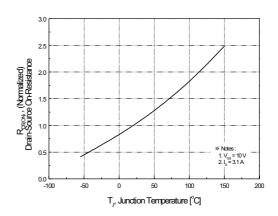


Figure 8. On-Resistance Variation vs. Temperature

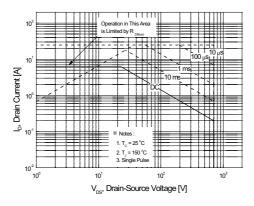


Figure 9. Maximum Safe Operating Area

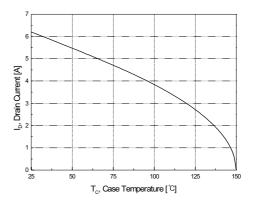


Figure 10. Maximum Drain Current vs. Case Temperature

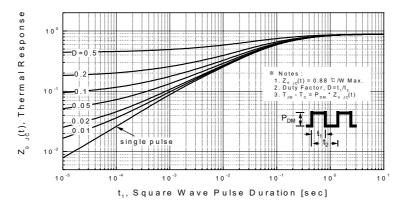
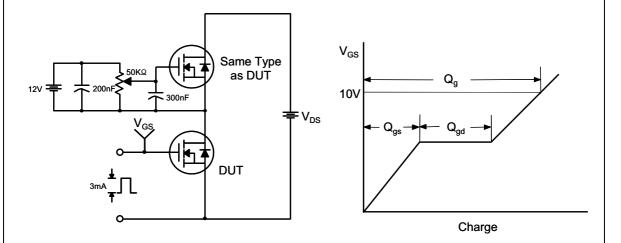


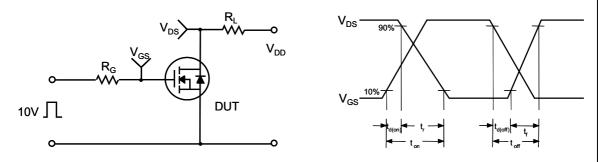
Figure 11. Transient Thermal Response Curve

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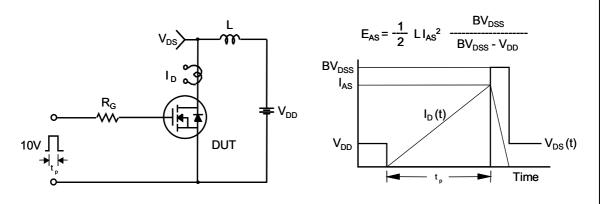
Gate Charge Test Circuit & Waveform



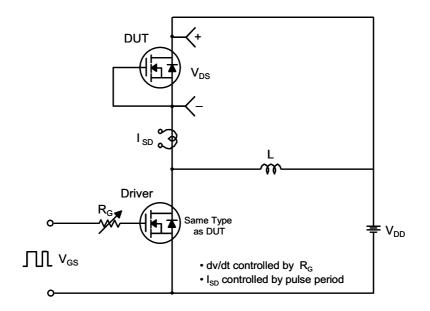
Resistive Switching Test Circuit & Waveforms

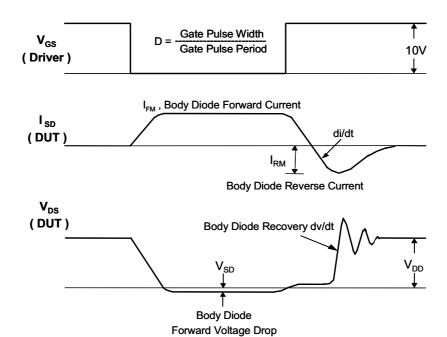


Unclamped Inductive Switching Test Circuit & Waveforms

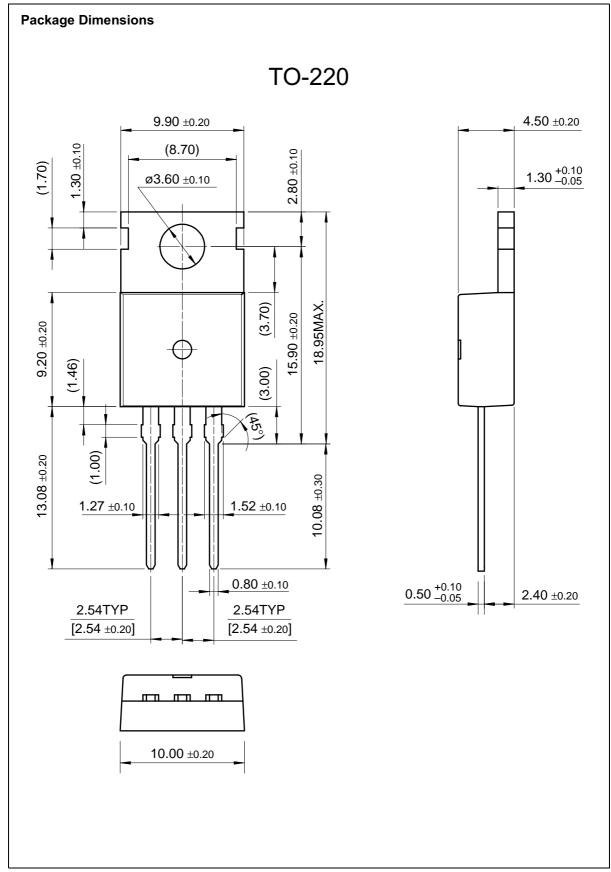


Peak Diode Recovery dv/dt Test Circuit & Waveforms





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